Hybrid IGBT 50 A, 650 V

Using the novel field stop 4th generation IGBT technology and the 1.5th generation SiC Schottky Diode technology, AFGHL50T65SQDC offers the optimum performance with both low conduction and switching losses for high efficiency operations in various applications, especially totem pole bridgeless PFC and Inverter.

Features

- AEC-Q101 Qualified
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.6 V (Typ.) @I_C = 50 A$
- Fast Switching
- Tighten Parameter Distribution
- No Reverse Recovery/No Forward Recovery

Typical Applications

- Automotive
- On & Off Board Chargers
- DC-DC Converters
- PFC
- Industrial Inverter

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector to Emitter Voltage		V _{CES}	650	V
Gate to Emitter Voltage Transient Gate to Emitter Vol	tage	V _{GES}	±20 ±30	V
Collector Current	@T _C = 25°C @T _C = 100°C	Ι _C	100 50	A
Pulsed Collector Current (Note 1)		I _{LM}	200	А
Pulsed Collector Current (No	te 2)	I _{CM}	200	А
Diode Forward Current	@T _C = 25°C @T _C = 100°C	١ _F	40 20	A
Pulsed Diode Maximum Forw	vard Current	I _{FM}	200	А
Maximum Power Dissipation	@T _C = 25°C @T _C = 100°C	PD	238 119	W
Operating Junction / Storage Temperature Range)	T _J , T _{STG}	±55 to +175	°C
Maximum Lead Temp. for Sol Purposes, 1/8" from case for		ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

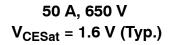
 V_{CC} = 400 V, V_{GE} = 15 V, I_C = 200 A, R_G = 26 Ω , Inductive Load, 100% Tested.

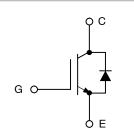
2. Repetitive Rating: pulse width limited by max. Junction temperature.



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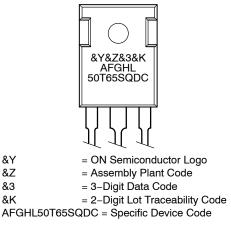
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MARKING DIAGRAM



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ORDERING INFORMATION

Device	Package	Shipping	
AFGHL50T65SQDC	TO-247-3L	30 Units / Rail	

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ hetaJC}$	0.63	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.55	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V,$ $I_{C} = 1 mA$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	_	0.6	_	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	-	-	250	μΑ
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	-	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 50 \text{ mA}$	V _{GE(th)}	3.4	4.9	6.4	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V_{GE} = 15 V, I _C = 50 A, T _J = 175°C	V _{CE(sat)}	-	1.6 1.9	2.1	V
DYNAMIC CHARACTERISTICS						
Input capacitance	V _{CE} = 30 V,	C _{ies}	-	3098	-	pF
Output capacitance	V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	265	-	
Reverse transfer capacitance		C _{res}	-	9	-	
Gate charge total	$V_{CE} = 400 V,$	Qg	_	94	_	nC
Gate to emitter charge	I _C = 50 V, V _{GE} = 15 V	Q _{ge}	_	18	_	
Gate to collector charge		Q _{gc}	_	23	_	
SWITCHING CHARACTERISTICS						
Turn-on delay time	$T_J = 25^{\circ}C$	t _{d(on)}	-	17.6	-	ns
Rise time	VCC = 400 V, IC = 12.5 A	t _r	-	6.4	-	1
Turn-off delay time	R _G = 4.7 Ω	t _{d(off)}	-	94.4	-	
Fall time	V _{GE} = 15 V Inductive Load	t _f	-	14.4	-	
Turn-on switching loss		Eon	-	131	-	μJ
Turn-off switching loss		E _{off}	-	96	-	1
Total switching loss		E _{ts}	_	227	-	
Turn-on delay time	$T_J = 25^{\circ}C$	t _{d(on)}	_	19.2	-	ns
Rise time	$\label{eq:VCC} \begin{array}{l} VCC = 400 \text{ V}, \\ IC = 25 \text{ A} \\ R_{G} = 4.7 \ \Omega \\ V_{GE} = 15 \text{ V} \\ Inductive Load \end{array}$	t _r	-	11.2	-	1
Turn-off delay time		td _(off)	_	89.6	-	1
Fall time		t _f	-	6.4	-	1
Turn-on switching loss	1	Eon	-	311	-	μJ
Turn-off switching loss		Eoff	-	141	-	1
Total switching loss	1	Ets	-	452	-	1

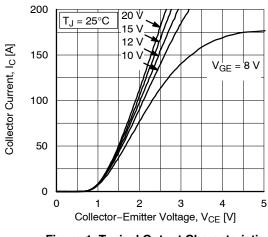
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

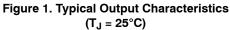
Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
SWITCHING CHARACTERISTICS				•		
Turn-on delay time	T _J = 175°C	t _{d(on)}	-	16	-	ns
Rise time	VCC = 400 V, IC = 12.5 A	t _r	_	8	-	
Turn-off delay time	R _G = 4.7 Ω V _{GE} = 15 V	t _{d(off)}	_	107.2	-	
Fall time	Inductive Load	t _f	_	53.6	-	
Turn-on switching loss		Eon	_	157	-	μJ
Turn–off switching loss		E _{off}	_	193	-	
Total switching loss		E _{ts}	_	350	-	1
Turn-on delay time	T _J = 175°C	t _{d(on)}	_	17.6	-	ns
Rise time	VCC = 400 V, IC = 25 A	t _r	_	14.4	-	
Turn-off delay time	R _G = 4.7 Ω V _{GE} = 15 V	t _{d(off)}	_	99.2	-	
Fall time	Inductive Load	t _f	_	9.6	-	
Turn-on switching loss		Eon	-	350	-	μJ
Turn–off switching loss		E _{off}	-	328	-	
Total switching loss		E _{ts}	-	678	-	
DIODE CHARACTERISTICS					•	•
Forward voltage	I _F = 20 A	V _F	-	1.45	1.75	V

Forward voltage	I _F = 20 A I _F = 20 A, T _J = 175°C	V _F	-	1.45 1.83	1.75 -	V
Total Capacitance	V _R = 400 V, f = 1 MHz	С	-	103	-	pF
	V _R = 600 V, f = 1 MHz		-	99	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





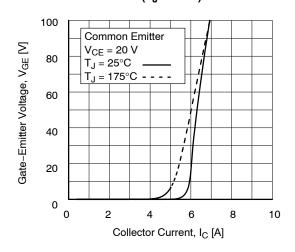


Figure 3. Transfer Characteristics

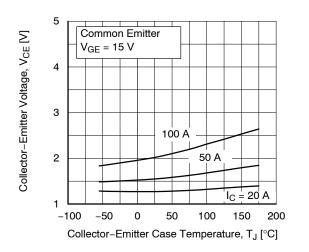


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

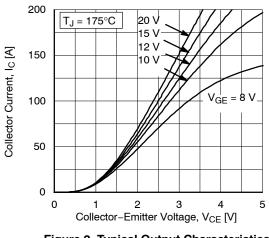
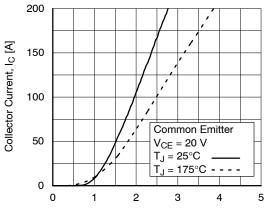


Figure 2. Typical Output Characteristics $(T_J = 175^{\circ}C)$



Collector-Emitter Voltage, V_{CE} [V]

Figure 4. Typical Saturation Voltage Characteristics

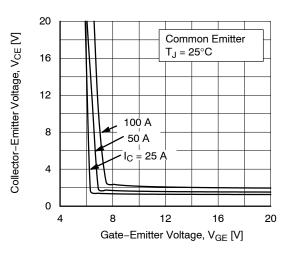
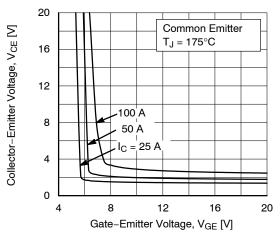
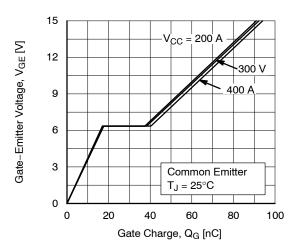


Figure 6. Saturation Voltage vs. V_{GE} (T_J = 25°C)

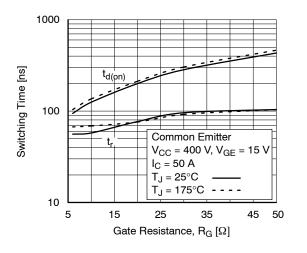
TYPICAL CHARACTERISTICS (continued)

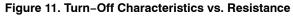


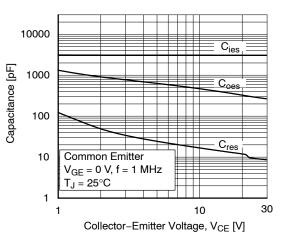














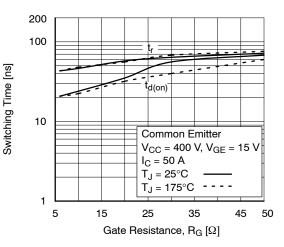


Figure 10. Turn-on Characteristics vs. Gate Resistance

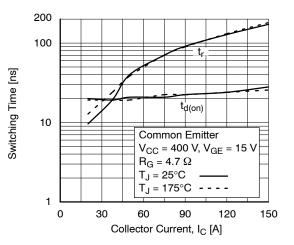
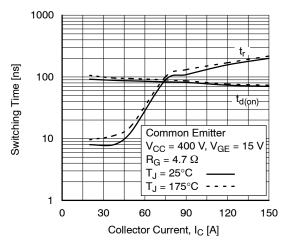
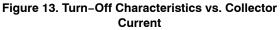


Figure 12. Turn-On Characteristics vs. Collector Current

TYPICAL CHARACTERISTICS (continued)





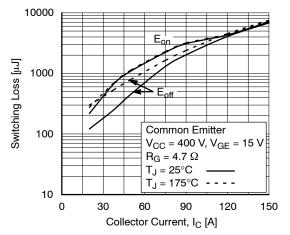


Figure 15. Switching Loss vs. Collector Current

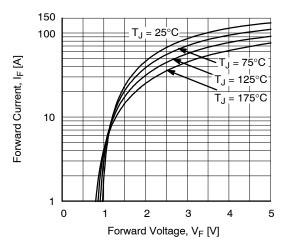


Figure 17. (Diode) Forward Characteristics vs. (Normal I–V)

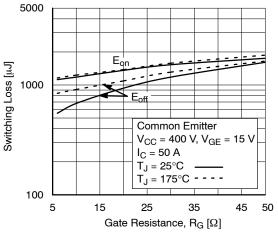


Figure 14. Switching Loss vs. Gate Resistance

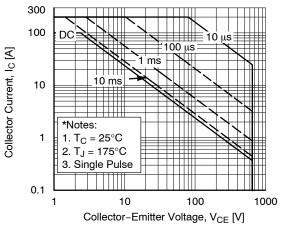
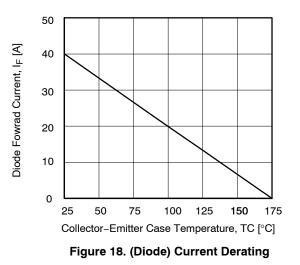


Figure 16. SOA Characteristics (FBSOA)



TYPICAL CHARACTERISTICS (continued)

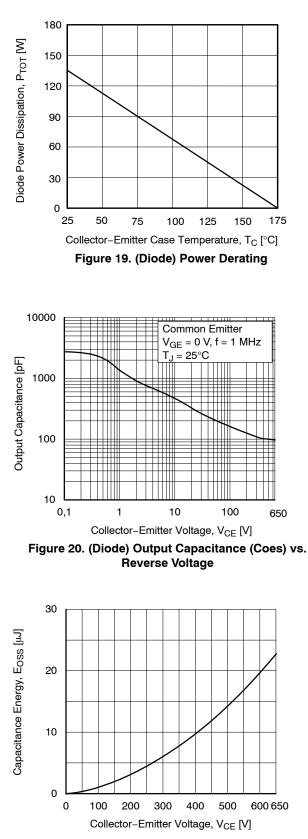
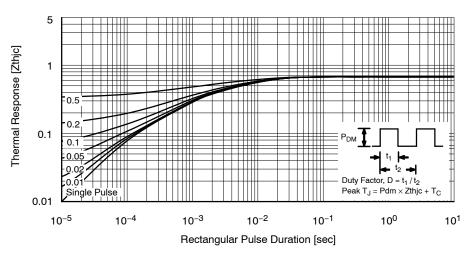


Figure 21. Output Capacitance Stored Energy





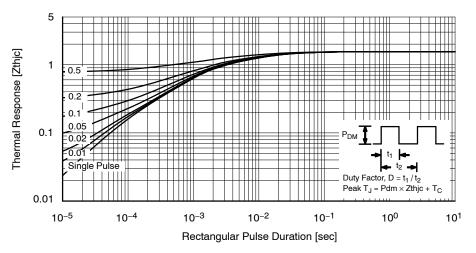


Figure 23. Transient Thermal Impedance of Diode



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